# PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

### **CONVEYING PARTY DATA**

Name	Execution Date
TAKAAKI HIOKA	02/28/2017
MIKA EBIHARA	02/28/2017
HIROSHI TAKAHASHI	02/27/2017
MATSUO KISHI	02/27/2017
MIEI TAKAHAMA	02/27/2017

### RECEIVING PARTY DATA

Name:	SII SEMICONDUCTOR CORPORATION	
Street Address:	8, NAKASE 1-CHOME, MIHAMA-KU	
City:	CHIBA-SHI, CHIBA	
State/Country:	JAPAN	
Postal Code:	261-8507	

## **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	15458499

### **CORRESPONDENCE DATA**

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Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

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ATTORNEY DOCKET NUMBER:	11106/919
NAME OF SUBMITTER:	TADASHI HORIE
SIGNATURE:	/Tadashi Horie/
DATE SIGNED:	03/14/2017

**Total Attachments: 3** 

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> PATENT REEL: 041572 FRAME: 0585

#### ASSIGNMENT

WHEREAS, <u>Takaaki HIOKA</u>, <u>Mika EBIHARA</u>, <u>Hiroshi TAKAHASHI</u>, <u>Matsuo KISHI</u>, and <u>Mici TAKAHAMA</u>, hereinafter called the "Assignors", have made the invention described in the United States patent application entitled <u>MAGNETIC SENSOR AND METHOD OF MANUFACTURING THE SAME</u>, executed by Assignors on the same date as, or on a date prior to, this Assignment;

WHEREAS, <u>SII Semiconductor Corporation</u>, a corporation organized and existing under the laws of <u>Japan</u>, having a place of business at <u>8</u>, <u>Nakase 1-chome</u>, <u>Mihama-ku</u>, <u>Chiba-shi</u>, <u>Chiba</u>, <u>Japan 261-8507</u>, hereinafter called the "Assignee", desires to acquire the entire right, title and interest in and to the invention and the patent application identified above, and all patents which may be obtained for said invention, as set forth below;

NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other valuable and legally sufficient consideration, the receipt of which by the Assignors from the Assignee is hereby acknowledged, the Assignors have sold, assigned and transferred, and by these presents do sell, assign and transfer to the Assignee, the entire right, title and interest for the United States in and to the invention and the patent application identified above, and any patents that may issue for said invention in the United States; together with the entire right, title and interest in and to said invention and all patent applications and patents therefor in all countries foreign to the United States, including the full right to claim for any such application all benefits and priority rights under any applicable convention; together with the entire right, title and interest in and to all continuations, divisions, renewals and extensions of any of the patent applications and patents defined above; to have and to hold for the sole and exclusive use and benefit of the Assignee, its successors and assigns, to the full end of the term or terms for all such patents.

The Assignors hereby covenant and agree, for both the Assignors and the Assignors' legal representatives, that the Assignors will assist the Assignee in the prosecution of the patent application identified above; in the making and prosecution of any other patent applications that the Assignee may elect to make covering the invention identified above; in vesting in the Assignee like exclusive title in and to all such other patent applications and

PATENT REEL: 041572 FRAME: 0586 patents; and in the prosecution of any interference which may arise involving said invention, or any such patent application or patent; and that the Assignors will execute and deliver to the Assignee any and all additional papers which may be requested by the Assignee to carry out the terms of this Assignment.

The Commissioner of Patents and Trademarks is hereby authorized and requested to issue patents to the Assignee in accordance with the terms of this Assignment.

IN TESTIMONY WHEREOF, the Assignors have executed this agreement.

DATE:	Feb. 28.2017	
WITNESSED:		Takaaki HIOKA
DATE:		
DATE:		
DATE:	Feb 28,2017	mike Wihara
WITNESSED:		Mika EBIHARA
DATE:		
DATE:		
DATE:	Feb. 27, 2017	Hersh Takehash
WITNESSED:		Hiroshi TAKAHASHI
DATE:		
DATE:		

DATE:	Feb. 27. 2017	Matsuo Kishi
WITNESSED:		Matsuo KISHI
DATE:		
DATE:		
DATE:	Feb. 27, 2017	Miei TAKAHAMA
WITNESSED:		Miei TAKAHAMA
DATE:		
DATE:		